





Power MOSFETS

DATASHEET

LM1A055NAK8A

N-Channel
Enhancement Mode MOSFET

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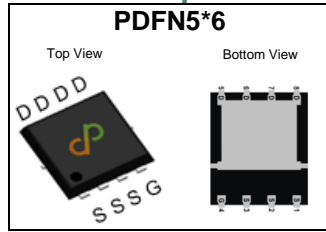


Quality Management Systems

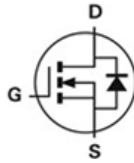
ISO 9001:2015 Certificate

N-Channel Enhancement Mode MOSFET

Pin Description



Symbol



Product Summary

Symbol	N-Channel	Unit
V_{DSS}	100	V
$R_{DS(ON)-Max}$	5.5	m Ω
I_D	103	A

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested

Applications

- Secondary Side Synchronous Rectification
- DC-DC Converter
- Motor Control

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM1A055NAK8A	PDFN5*6	Tape & Reel	5000 / Tape & Reel	1A055 □□□□□□

Absolute Maximum Ratings (T_J=25°C Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit	
V_{DSS}	Drain-Source Voltage	100	V	
V_{GSS}	Gate-Source Voltage	±20		
T_J	Maximum Junction Temperature	150	°C	
T_{STG}	Storage Temperature Range	-55 to 150	°C	
$I_{DM}^{①}$	Pulse Drain Current Tested	$T_C=25^\circ C$	142	A
I_D	Continuous Drain Current	$T_C=25^\circ C$	103	A
		$T_C=100^\circ C$	65	
P_D	Maximum Power Dissipation	$T_C=25^\circ C$	89	W
		$T_C=100^\circ C$	36	
$I_{AS}^{②}$	Avalanche Current, Single pulse	L=0.1mH	38	A
$E_{AS}^{③}$	Avalanche Energy, Single pulse	L=0.1mH	72	mJ

Thermal Characteristics

Symbol	Parameter	Rating	Unit	
$R_{\theta JC}$	Thermal Resistance-Junction to Case	Steady State	1.4	°C/W
$R_{\theta JA}^{③}$	Thermal Resistance-Junction to Ambient	Steady State	50	°C/W

Note ① : Max. current is limited by bonding wire

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz

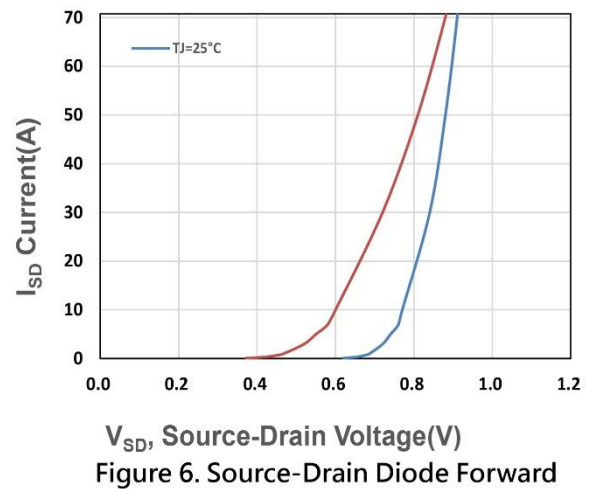
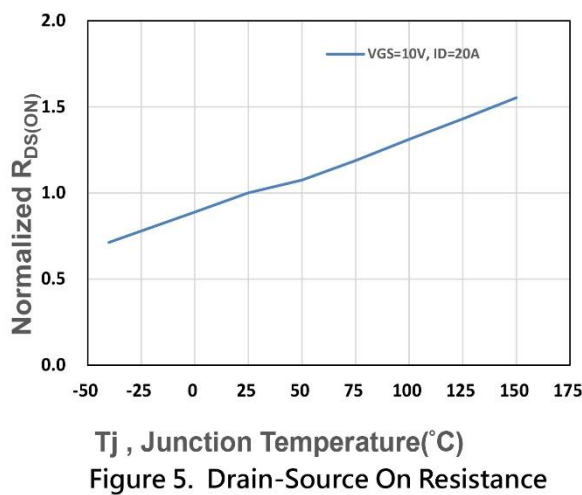
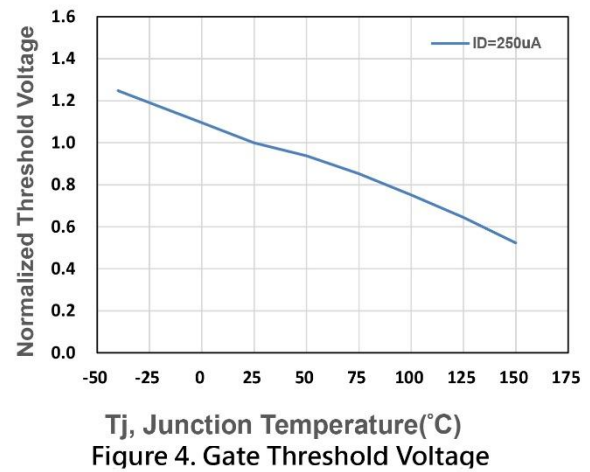
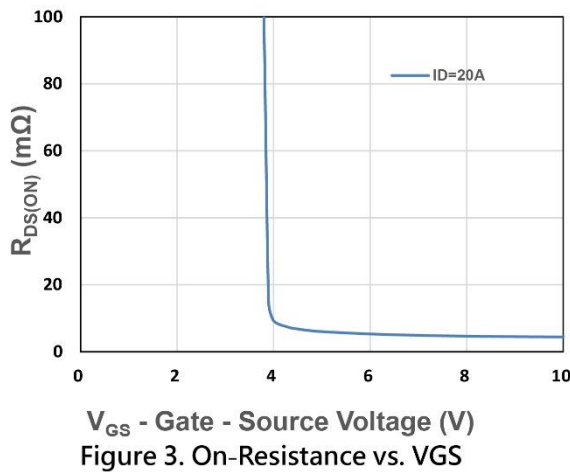
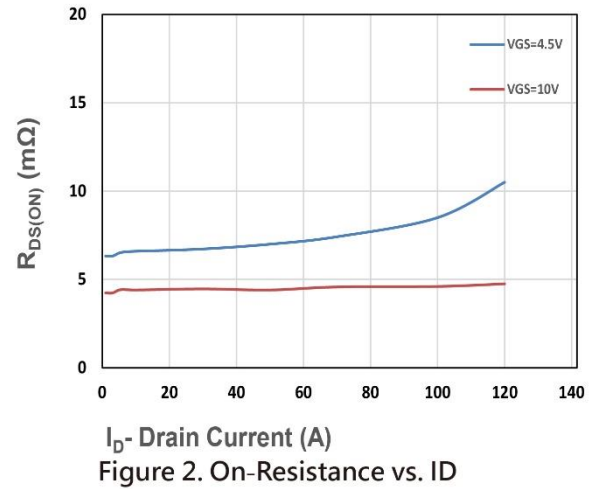
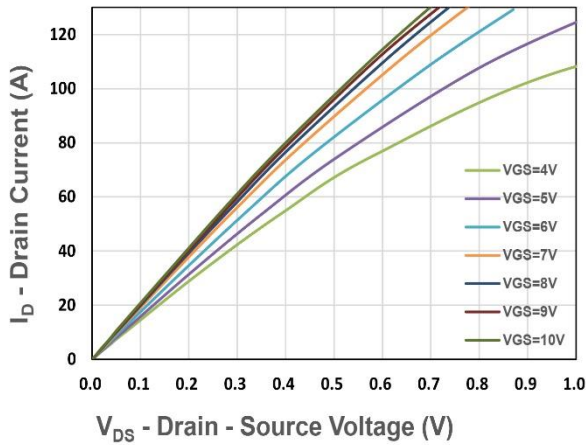
N-Channel Electrical Characteristics (T_J=25°C Unless Otherwise Noted)

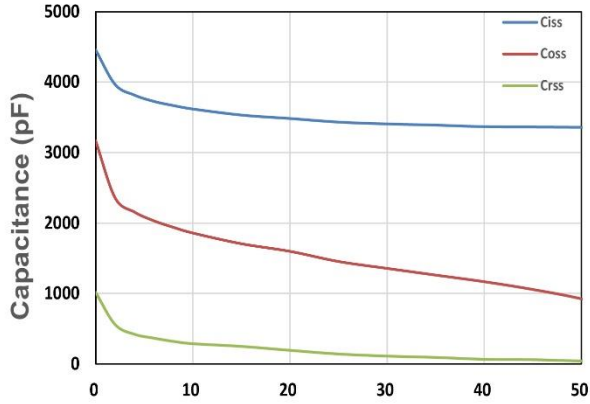
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250uA	100	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	V _{DS} =80V, V _{GS} =0V	-	-	1	uA
V_{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250uA	1	2	3	V
I_{GSS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
R_{DS(ON)}^④	Drain-Source On-state Resistance	V _{GS} =10V, I _{DS} =20A	-	4.5	5.5	mΩ
		V _{GS} =4.5V, I _{DS} =10A	-	6.5	8.5	
g_{fs}	Forward Transconductance	V _{DS} =5V, I _{DS} =10A	-	30.2	-	S
Dynamic Characteristics[®]						
R_G	Gate Resistance	V _{GS} =0V, V _{DS} =0V, Freq.=1MHz	-	0.5	-	Ω
C_{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =50V, Freq.=1MHz	-	3358	-	pF
C_{oss}	Output Capacitance					
C_{rss}	Reverse Transfer Capacitance					
t_{d(ON)}	Turn-on Delay Time	V _{GS} =10V, V _{DS} =25V, I _D =1A, R _{GEN} =3Ω	-	13.3	-	nS
t_r	Turn-on Rise Time					
t_{d(OFF)}	Turn-off Delay Time					
t_f	Turn-off Fall Time					
Q_g	Total Gate Charge	V _{GS} =4.5V, V _{DS} =50V, I _D =20A	-	32.9	-	nC
Q_g	Total Gate Charge	V _{GS} =10V, V _{DS} =50V, I _D =20A	-	64.3	-	
Q_{gs}	Gate-Source Charge		-	15.2	-	
Q_{gd}	Gate-Drain Charge		-	14.6	-	
Source-Drain Characteristics						
V_{SD}^④	Diode Forward Voltage	I _{SD} =10A, V _{GS} =0V	-	0.8	1.1	V
t_{rr}	Reverse Recovery Time	I _F =20A, V _R =50V	-	47.7	-	nS
Q_{rr}	Reverse Recovery Charge	dI _F /dt=100A/μs	-	59.4	-	nC

Note ④ : Pulse test (pulse width≤300us, duty cycle≤2%).

Note ⑤ : Guaranteed by design, not subject to production testing.

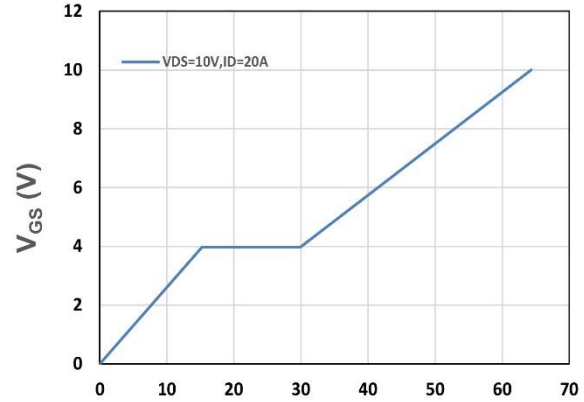
N-Channel Typical Characteristics





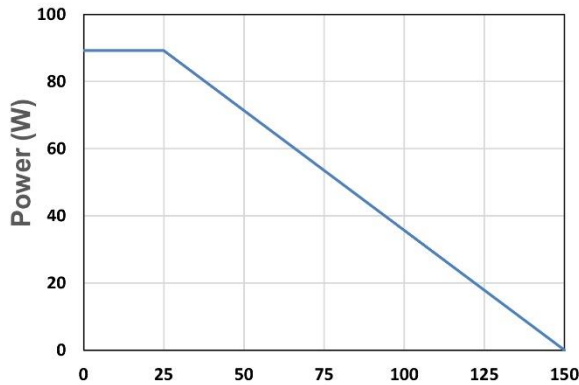
V_{DS} - Drain - Source Voltage (V)

Figure 7. Capacitance



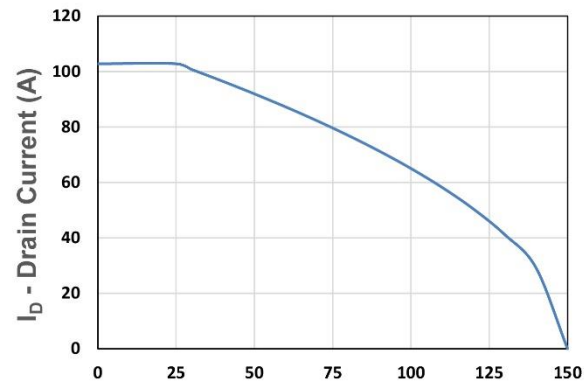
Q_g , Total Gate Charge (nC)

Figure 8. Gate Charge Characteristics



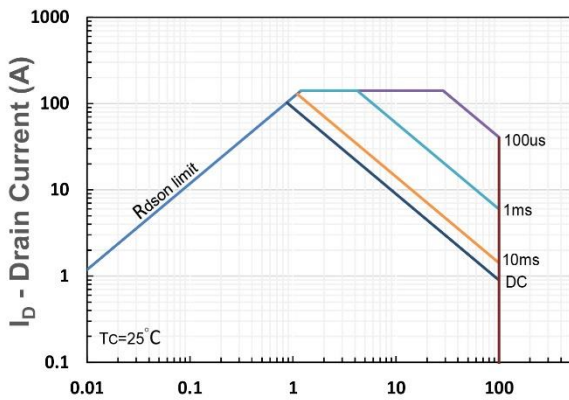
T_c - Case Temperature ($^{\circ}C$)

Figure 9. Power Dissipation



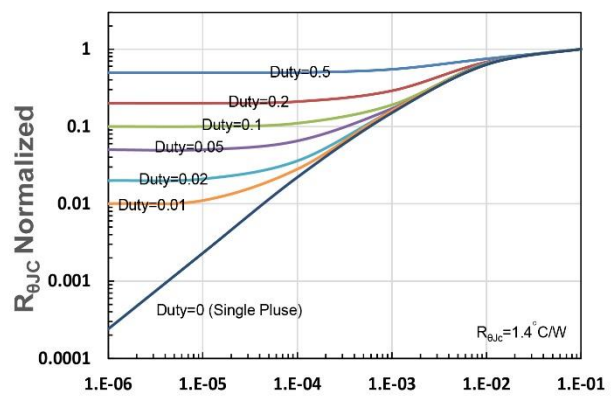
T_c - Case Temperature ($^{\circ}C$)

Figure 10. Drain Current



V_{DS} - Drain-Source Voltage (V)

Figure 11. Safe Operating Area



t_1 , Square Wave Pulse Duration (s)

Figure 12. $R_{\theta JC}$ Transient Thermal Impedance